**FORM PTQ-1595** 1-31-92

U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office Docket No. ROC920050271US1

## RECORDATION FORM COVER SHEET PATENTS ONLY

o the Assistant Commissioner for Patents. Please record the attached original documents or copy thereof.	
Name of conveying party(les):     JOHN LEE COLBERT     MARK KENNETH HOFFMEYER	Name and address of receiving party(les):     Name: International Business Machines Corporation
Additional names of conveying party(ies) attached? □ yes ಠ no	Internal Address:
3. Nature of Conveyance	
⊗ Assignment □ Merger □ Security Agreement □ Change of Name □ Other □ □ □ Other □ □ Other □ □ Other □ □ Other □ □ □ Other □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □ □	Street Address: New Orchard Road City Armonk State New York Zip 10504
Execution Date: Dec. 20, 2005 and Dec. 20, 2005.	Additional name(s) & address(es) attached? □ yes @ no
4. Application number(s) or patent number(s): TITLE: HIGH PERFORMANCE REWORKABLE HEATSINK AND PACKAGING STRUCTURE WITH SOLDER RELEASE LAYER AND METHOD OF MAKING	
If this document is being filed together with a new application, the execution date of the application is	
A, Patent Application No(s).	B. Patent No(s).
Docket No.: ROC920050271US1 Serial No.: ///3/6, みんり	
Additional numbers attached? □ Yes  No	
Name and address of party to whom correspondence concerning document should be mailed:	Total number of applications and patents involved:
Dake & C. Millianno	7. Total fee (37 CFR 3.41): \$ 40.00
Robert R. Williams IBM Corporation - Dept. 917 3605 Highway 52 North	□ Enclosed
Rochester, MN 55901-7829	<ul> <li>Authorized to be charged to deposit account</li> <li>Total fee due</li> <li>Any deficiencles in the enclosed fees</li> </ul>
	8. Deposit account number:
	09-0465
	(Attach duplicate copy of this page if paying by deposit account)
DO NOT USE THIS SPACE	
9. Statement and signature	
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the	
original document.	
Robert R. Williams, #48,395 Name of Person Signing  Robert R. Williams, #48,395 Signature  1/12/06 Date	
Total number of pages comprising cover sheet: 3	

**PATENT REEL: 017182 FRAME: 0413** 

Docket No. ROC920050271US1

## **ASSIGNMENT**

Whereas, we

John Lee Colbert (1) County of Olmsted

City of Byron. and State of Minnesota,

Mark Kenneth Hoffmeyer (2) County of Olmsted

City of Rochester. and State of Minnesota,

have invented certain improvements in

## HIGH PERFORMANCE REWORKABLE HEATSINK AND PACKAGING STRUCTURE WITH SOLDER RELEASE LAYER AND METHOD OF MAKING

and have executed, respectively, a United States patent application therefor on

Dates Inventors Signed

Dec. 20 Declaration (1)

, 2005 (2) Dec. 20

, 2005

And whereas, INTERNATIONAL BUSINESS MACHINES CORPORATION, a corporation of New York, having a place of business at Armonk, New York 10504, (hereinafter called IBM), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, we the above named hereby sell, assign, and transfer to IBM, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and we request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to IBM, its successors and assigns; and we hereby agree that IBM may apply for foreign Letters Patent on said invention and we will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by IBM.

PATENT

REEL: 017182 FRAME: 0414

## Docket No. ROC920050271US1

Inventor (1)

Inventor (2)

at Rochester, Minnesota (John Lee Colbert)

Inventor (3)

Inventor (4)

Inventor (1)

Inventor (John Lee Colbert)

First Name Initial Last Name

Inventor (Mark Kenneth Hoffmeyer)

First Name Initial Last Name

Inventor Signature

RECORDED: 01/12/2006

PATENT REEL: 017182,FRAME: 0415 \*\*